# 3A, 100V - 200V Ultra Fast Surface Mount Rectifier

### FEATURES

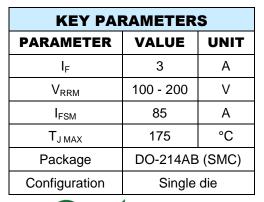
- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.200g (approximately)







DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	PU3BCH	<b>PU3DCH</b>	UNIT
Marking code on the device			PU3BC	PU3DC	
Repetitive peak reverse voltage		V <sub>RRM</sub>	100	200	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	70	140	V
Forward current		١ <sub>F</sub>	3		Α
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	1	8	5	- A
	t = 1.0ms	I <sub>FSM</sub>	18	80	
Junction temperature		TJ	-55 to +175		°C
Storage temperature		T <sub>STG</sub>	-55 to +175		°C



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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R <sub>θJL</sub>	14	°C/W
Junction-to-ambient thermal resistance	R <sub>θJA</sub>	58	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	16	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 1.5A, T_J = 25^{\circ}C$		0.81	-	V
	$I_F = 3.0A, T_J = 25^{\circ}C$	N	0.86	0.93	V
	$I_F = 1.5A, T_J = 125^{\circ}C$	V <sub>F</sub>	0.66	-	V
	$I_F = 3.0A, T_J = 125^{\circ}C$		0.73	-	V
Reverse current @ rated $V_R^{(2)}$	$T_J = 25^{\circ}C$		-	2	μA
	T <sub>J</sub> = 125°C	I <sub>R</sub>	-	10	μA
Junction capacitance	$1MHz, V_R = 4.0V$	CJ	47	-	pF
Deverse receivery time	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$		-	25	ns
Reverse recovery time	$I_F = 1.0A$ , di/dt = 50A/µs, $V_R = 30V$	t <sub>rr</sub>	31	-	
Reverse recovery current		I <sub>RM</sub>	4.9	-	А
Reverse recovery charge	I <sub>F</sub> = 3.0A, di/dt = 200A/μs, V <sub>R</sub> = 100V	Q <sub>rr</sub>	51	-	nC
Reverse recovery time		t <sub>rr</sub>	23	-	ns

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING	
PU3xCH	DO-214AB (SMC)	3,000/ Tape & Reel	

Notes:

1. "x" defines voltage from 100V(PU3BCH) to 200V(PU3DCH)



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

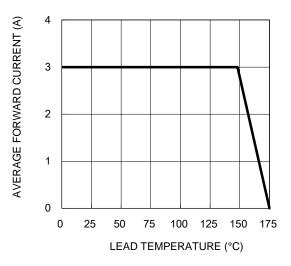
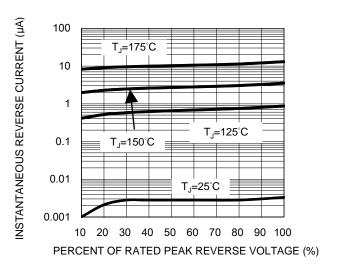


Fig.1 Forward Current Derating Curve

#### **Fig.3 Typical Reverse Characteristics**



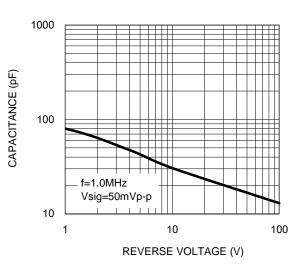
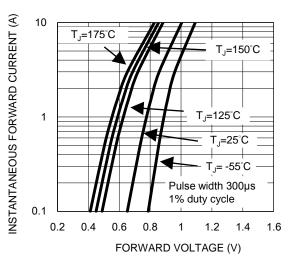
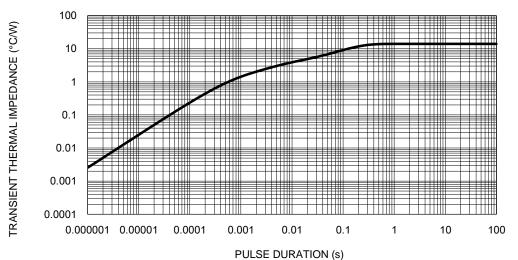


Fig.2 Typical Junction Capacitance

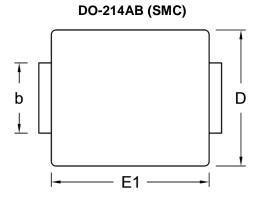
**Fig.4 Typical Forward Characteristics** 

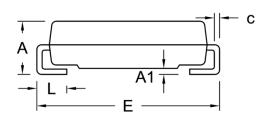






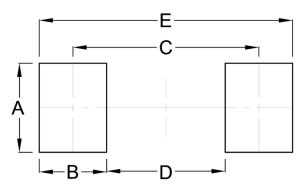
### **PACKAGE OUTLINE DIMENSIONS**





DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
с	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

### SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

### **MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound

YW = Date Code

F = Factory Code



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